



ESD SMD Comm COG, Ceramic, 0.047 uF, 1%, 63 VDC, COG, SMD, MLCC, Temperature Stable, Electro Static Discharge, Class I, 1206, 1.5 mm



General Information	
Series	ESD SMD Comm COG
Style	SMD Chip
Description	SMD, MLCC, Temperature Stable, Electro Static Discharge, Class I
Features	Temperature Stable, Low ESR, Class I
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Typical Component Weight	36 mg
Shelf Life	78 Weeks
MSI	1

0.047 uF

21.2766 GOhms

1206
3.3mm +/-0.4mm
1.6mm +/-0.35mm
1.6mm +/-0.20mm
1.5mm MIN
0.6mm +/-0.25mm

	Measurement Condition	1 kHz 1.0Vrms
	Tolerance	1%
	Voltage DC	63 VDC
	ESD Level per AEC-Q200	25,000 V ESD Level
	Dielectric Withstanding Voltage	157.5 VDC
	Temperature Range	-55/+125°C
	Temp. Coefficient	COG
ape	Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
	Dissipation Factor	0.1% 1 kHz 1.0Vrms
	Aging Rate	0% Loss/Decade Hour

Specifications
Capacitance

Insulation Resistance

Packaging Specifications	
Packaging	T&R, 330mm, Plastic Tape
Packaging Quantity	8000

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